



10A, 200V Trench Schottky Rectifier

FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss/ high efficiency
- High forward surge capability
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

MECHANICAL DATA

• Case: TO-262 (I²PAK)

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 1A whisker test

Polarity: As marked

• Weight: 1.60g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	10	Α		
V_{RRM}	200	V		
I _{FSM}	100	Α		
T _{J MAX}	150 °C			
Package	TO-262 (I ² PAK)			
Configuration	Dual dies			

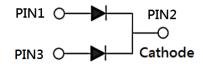








TO-262 (I²PAK)



PARAMETER	SYMBOL	TSI10H200CW	UNIT
Marking code on the device		TSI10H200CW	
Repetitive peak reverse voltage	V _{RRM}	200	V
Reverse voltage, total rms value	V _{R(RMS)}	140	V
Forward current	I _F	10	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	100	А
Critical rate of rise of off-state voltage	dv/dt	10,000	V/µs
Junction temperature	TJ	-55 to +150	°C
Storage temperature	T _{STG}	-55 to +150	°C

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TSI10L200CW
Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	TINU	
Junction-to-case thermal resistance	$R_{\Theta JC}$	5	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	I _F = 5A, T _J = 25°C	V _F	0.84	0.90	V
	$I_F = 10A, T_J = 25^{\circ}C$		0.92	0.98	V
	I _F = 5A, T _J = 125°C		0.72	0.78	V
	$I_F = 10A, T_J = 125^{\circ}C$		0.80	0.86	V
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C	I _R	-	50	μΑ
	T _J = 125°C		-	5	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TSI10L200CW	TO-262 (I ² PAK)	50 / Tube		



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

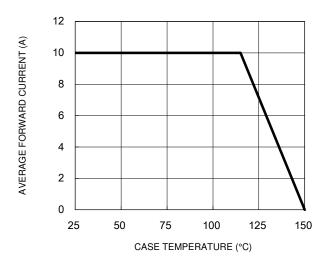


Fig.3 Typical Reverse Characteristics

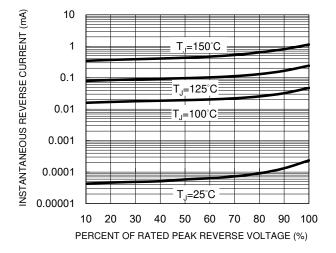


Fig.2 Typical Junction Capacitance

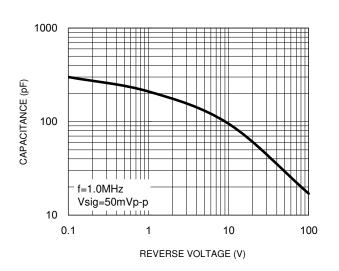
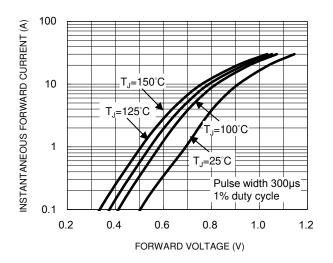
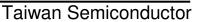


Fig.4 Typical Forward Characteristics

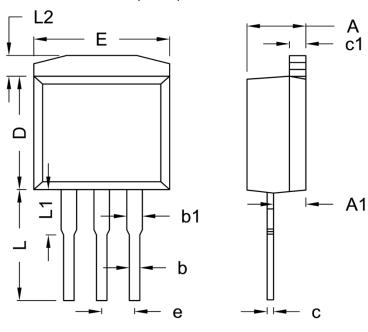






PACKAGE OUTLINE DIMENSIONS

TO-262 (I²PAK)



DIM	Unit (mm)		Unit ((inch)
DIN	Min	Max	Min	Max
Α	4.40	4.70	0.173	0.185
A1	2.20	2.80	0.087	0.110
b	0.68	0.94	0.027	0.037
b1	0.95	1.45	0.037	0.057
С	0.35	0.64	0.014	0.025
c1	1.14	1.40	0.045	0.055
D	8.25	9.25	0.325	0.364
E	-	10.50	-	0.413
е	2.41	2.67	0.095	0.105
L	7.79	9.35	0.307	0.368
L1	2.80	4.20	0.110	0.165
L2	1.600	1.600 (TYP.)		(TYP.)

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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